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(54) **Superconducting element**

(57) A superconducting element comprising a high temperature superconducting film deposited on a technical substrate (1) consisting of a stainless steel which is composed of

C	0 to 0.20%
Si	1.5 to 2.5 %
Mn	0 to 2.00 %
P	0 to 0.045 %
S	0 to 0.030 %
Cr	18.0 to 28.0 %
Ni	16.0 to 25.0 %
N	0 to 0.11 %, rest iron and unavoidable impurities.

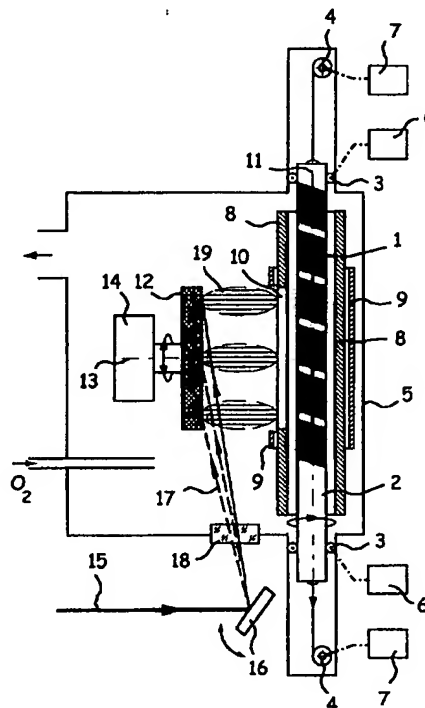


Fig. 1

Description

[0001] The present invention relates to a superconducting element comprising a high temperature superconducting film deposited on a technical substrate consisting of a stainless steel containing Ni, Cr, and Fe and possible further alloying elements, preferably Mn and Si.

[0002] The recent progress in the technology of high temperature superconducting (HTSC) films demonstrates the first real possibility of obtaining high T_c superconducting layers with high critical current densities (j_c) of $> 4 \text{ MA/cm}^2$ on various single crystalline substrates. A lot of methods based on pulsed laser deposition, molecular beam deposition, sputtering, etc. were developed and successfully applied for this purpose.

[0003] A crucial point in these developments is an adequate choice of the substrate material which can be manufactured in larger pieces (from 1 to 100 m) and which is not as expensive as single crystals. Because of this reason, a lot of attempts have been made to employ for this aim a number of different "technical" materials as Ni (Garcia-Moreno Usoskin, Freyhardt et al., IOP Conf. Ser. 158 (1997) 909 - 912), Yttrium Stabilised Zirconia (YSZ) ceramics (Kinder et al. IEEE Trans. on Appl. Superconductivity, Vol. 5 No. 2 (1995) 1575 - 1580), Hastelloy (Quiton et al. in High Temperature Superconductivity, Research review 1998, ed. W.Y. Liang, 135 - 141), Inconel, etc. Between the HTSC films and the substrate a buffer layer is deposited which serves for influencing the texture of the deposited HTSC film and for acting as a diffusion barrier inhibiting an ion diffusion between substrate and HTSC film. The most usual HTSC film which is preferably used for the present invention is $\text{YBa}_2\text{Cu}_3\text{O}_{7-x}$. In the case of polycrystalline substrates of the above-mentioned kind an artificially induced alignment by ion-beam assisted deposition (IBAD) Iijima et al., J. Appl. Phys. 74 (1993), 1905, inclined substrate deposition (ISD) (Hasegawa et al. The 1998 Internationale Workshop on Superconductivity, 73 - 76) of the buffer layers or rolling assisted biaxially texturing of metallic substrate (RABiTs) (Goyal et al., Appl. Phys., Lett. 69, 1795) is required to provide a well textured growth of high- T_c films.

[0004] Nevertheless, no substrate material with sufficient properties has been found for long HTSC coated tapes. E.g. Ni sheets exhibit a high performance when used for smaller ($1 \times 1 \text{ cm}^2$) substrates. For longer ($> 10 \text{ cm}$) substrates a destruction of high- T_c film occurs which is caused by local oxidation of the substrate because of oxygen diffusion through weak parts in the buffer layer. This is also valid for Inconel and, partly, for Hastelloy substrates. Ceramic substrates are shown to be sufficient to provide high critical currents in superconducting films, but they are not flexible enough to perform a winding in coils. All of substrates mentioned above are expensive. One square meter of each of them costs at present more than 1.000 DM.

[0005] The above-mentioned draw backs inhibit the use of HTSC films for new numerous fields of their industrial applications in electronics, HF-technique and power engineering where HTSC films on a single crystalline substrate are useless because of their strictly limited dimensions and lacking mechanical flexibility.

[0006] EP 0 312 015 A2 discloses a substrate for an oxide superconductor shaped body which is formed of an Fe-Ni-Cr steel alloy, e.g. SUS-310 or SUS-410. For these substrates a barrier layer of a noble metal is positioned between the substrate and the superconductor. Therefore, the costs of a superconducting element of this kind are high.

[0007] Accordingly, it is an object of the present invention to provide a superconducting element of the above-mentioned kind which provides a high critical current density and a high transition temperature and allows a reduction of production costs.

[0008] According to the present invention this problem is solved by a superconducting element comprising a high temperature superconducting film deposited on a technical substrate consisting of a stainless steel which is composed of

C	0 to 0.20 %
Si	1.5 to 2.5 %
Mn	0 to 2.00 %
P	0 to 0.045 %
S	0 to 0.030 %
Cr	18.0 to 28.0 %
Ni	16.0 to 25.0 %
N	0 to 0.11 %, ,

rest iron and unavoidable impurities.

[0009] Preferably the Si content lies between 1.6 or more preferred 1.7 and 2.5 %.

[0010] The superconducting element according to the present invention allows both an unexpected increase of the critical current densities and transition temperatures of high temperature superconducting films and to reduce drastically substrate price, at least, by a factor of 100. A reason of the improved film performance may be the optimal combination of the properties of the chosen substrate material, namely austenitic microstructure, high thermal expansion, peculi-

arities of surface structure, temperature resistance against oxidation, etc.

[0011] In a preferred embodiment of the present invention the steel shows an heat elongation of 15 to 18, preferably $17 \times 10^{-6}/K$ between 20° and 400 °C, of 16 to 19, preferably $18 \times 10^{-6}/K$ between 20° and 800 °C, of 17 to 20, preferably $19 \times 10^{-6}/K$ between 20° and 1000 °C and of 18 to 20.5, preferably $19.5 \times 10^{-6}/K$ between 20° and 1200 °C.

[0012] A preferred steel according to the present invention is known under the EURO norm designation X15CrNiSi25-21 or as X15CrNiSi25-20 according to DIN E EN 10095 (12/95) and has Cr content of 24.0 to 26.0 % and a Ni content of 19.0 to 22.0 %. Said steels are normally used as parts of furnaces which are heat resistant and have a high mechanical strength. The most preferred embodiment of the invention is a superconductor coated tape of the stainless steel as described.

Brief description of the drawings

[0013] Figure 1 is a view schematically illustrating an apparatus for preparation of HTSC films on ribbon-type substrates in accordance with an embodiment of the present invention.

Description of the preferred embodiment

[0014] In the apparatus illustrated in figure 1 a foil substrate 1 consisting of stainless steel is fixed in a helix form on a cylindrical tubular holder 2 with an outer diameter of 68 mm and mounted together with the holder in a motion guide based on rotating supports 3 and linear pulling devices 4 built in a vacuum chamber 5. The rotating supports as well as the pulling devices 4 are connected to motor drives 6, 7, respectively. In a film deposition area the substrate 1 with the holder 2 can be heated by a tubular quasi-equilibrium heater which consists of a heating element 8 and a rotating chopper 9. Heating element 8 is provided with one deposition window 10 and the chopper 9 is equipped with three of similar windows. All of the parts mentioned above are installed co-axially relatively to the rotation axis 11 of the tubular holder 2. Opposite to the deposition window 10 a ceramic target 12 is placed in the vacuum chamber 5. The target is based on $YBa_2Cu_3O_7$ composition. The target 12 is capable of linear oscillation direction perpendicular to the plane of the drawing of figure 1 and is capable also of periodic turns around axis 13 to provide variations of the azimuth of incoming layer beam relatively to the target. This allows to stabilise the laser plume during a long-term deposition process. The motions of the target 12 are provided by a 2-dimensional drive 14. To provide a large area pulsed laser deposition, the target 12 can be ablated by a pulsed laser beam 15 which after a reflection at an oscillating mirror 16 is capable of scanning the target surface by a deflected beam 17 entering the vacuum chamber 5 through a window 18. An excimer laser with a wave-length of 308 nm, an energy of pulses of 0,5 J, and a pulse repetition rate of 300 Hz was employed as a source of the laser beam.

[0015] In operation, the chamber is pumped down to a pressure of $< 10^{-3}$ mbar and the substrate 1 with the holder 2 are heated up to the temperature of 760 °C. During the heating step and subsequent film deposition the chopper 9 rotates with the frequency of 23 Hz, and holder 2 rotates with the frequency of 4 Hz. Then the oxygen pressure of 0,4 mbar is introduced to the chamber. The oscillating motions of target 12 and of mirror 16 and the axial pulling of the holder 2 are started. The laser is turned on and the laser pulses are synchronised with phases of motions of chopper 9 and of mirror 16 so that each ablation pulse appears only at the moment when one of the deposition windows in the rotating chopper 9 coincides with the deposition window 10 in the heating element 8, i.e. the substrate 1 is exposed to a plasma plume 19. Due to the rotation of the holder 2 and scanning of the target surface with the laser beam, a homogeneous film deposition over the substrate surface is provided. After the film deposition the oxygen pressure in the chamber is increased up to 300 mbar within 10 min. Simultaneously, the substrate temperature is reduced down to 500 °C during said 10 min. and afterwards down to 150 °C during next 60 min.

Example 1

[0016] 0.1 mm-thick stainless steel with a composition of Ni 19 %, Cr 24 %, Si 2 %, Mn 1 %, and with the rest of iron was used as the substrate 1. Substrate surface was galvanically polished in water solution of H_3PO_4 (30 %), CrO_3 (15 %) and H_2SO_4 (7 %) using a current density of 0.5 A/cm². Polishing time was of 10 s. After the polishing the substrate 1 was thoroughly washed in de-ionized water in supersonic bath. Then the substrate was covered with an Yttrium Stabilised Zirconia 1 m-thick buffer layer by IBAD.

[0017] By using the apparatus illustrated in figure 1 and described above the $YBa_2Cu_3O_7$ film was deposited which showed a density of the critical current in said superconducting film measured at the temperature of 77 K of 2 MA/cm². Transition temperature was 90 K. No substrate oxidation was observed after 120 min. lasting film deposition process.

[0018] The price of the substrate is of 20 DM/m².

Example 2

[0019] A 0.1 mm-thick stainless steel with the composition of Ni 25 %, Cr 24 %, Si 1,5 %, Mn 2 %, and with the rest of iron was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0020] The density of the critical current in the superconducting film was of 1.8 MA/cm². Transition temperature was 90 K. No substrate oxidation was observed after 120 min. lasting film deposition process.

[0021] The price of the substrate is of 25 DM/m².

Example 3

[0022] A 0.1 mm-thick stainless steel with the composition of Ni 16 %, Cr 24 %, Si 2 %, Mn 1 %, and with the rest of iron was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0023] The density of the critical current in the superconducting film was of 1.5 MA/cm². Transition temperature was 89 K. No substrate oxidation was observed after 120 min. lasting film deposition process.

[0024] The price of the substrate is of 20 DM/m².

Example 4

[0025] A 0.1 mm-thick stainless steel with the composition of Ni 19 %, Cr 18 %, Si 2 %, Mn 2 %, and with the rest of iron was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0026] The density of the critical current in the superconducting film was of 1.7 MA/cm². Transition temperature was 89 K. No substrate oxidation was observed after 120 min. lasting film deposition process.

[0027] The price of the substrate is of 18 DM/m².

Example 5

[0028] A 0.1 mm-thick stainless steel with the composition of Ni 19 %, Cr 28 %, Si 1.5 %, Mn 1 %, and with the rest of iron was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0029] The density of the critical current in the superconducting film was of 1.5 MA/cm². Transition temperature was 88 K. No substrate oxidation was observed after 120 min. lasting film deposition process.

[0030] The price of the substrate is of 25 DM/m².

Example 6

[0031] The stainless steel of example 1 was used, by instead of galvanic polishing the substrate was annealed at 850 °C in vacuum during 2 hours.

[0032] The density of the critical current in the superconducting film was of 1.7 MA/cm². Transition temperature was 90 K. No substrate oxidation was observed after 120 min. lasting film deposition process.

[0033] The price of the substrate is of 20 DM/m².

Example 7

[0034] A 0.1 mm-thick stainless steel with the composition of Ni 8 %, Cr 18 %, Mn 2 %, and with the rest of iron was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0035] The density of the critical current in the superconducting film was of 0.1 MA/cm². Transition temperature was 88 K. A pronounced substrate oxidation was observed after 120 min. lasting film deposition process.

[0036] The price of the substrate is of 15 DM/m².

Example 8

[0037] A 0.1 mm-thick stainless steel with the composition of Ni 9 %, Cr 18 %, Ti 0,5 %, Mn 2 %, and with the rest of iron was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0038] The density of the critical current in the superconducting film was of 0.1 MA/cm². Transition temperature was 88 K. A pronounced substrate oxidation was observed after 120 min. lasting film deposition process.

[0039] The price of the substrate is of 22 DM/m².

Example 9

[0040] A 0.1 mm-thick stainless steel with the composition of Ni 57 %, Cr 16 %, Fe 6 %, Mo 17 %, W 5 % (Hastelloy C) was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0041] The density of the critical current in the superconducting film was of 1.5 MA/cm². Transition temperature was 88 K. A local substrate oxidation was observed after 120 min. lasting film deposition process.

[0042] The price of the substrate is of 2,700 DM/m².

Example 10

[0043] A 0.1 mm-thick stainless steel with the composition of Ni 100 % (Nickel) was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0044] The density of the critical current in the superconducting film was of 1.4 MA/cm². Transition temperature was 88 K. A pronounced substrate oxidation was observed after 120 min. lasting film deposition process.

[0045] The price of the substrate is of 1,300 DM/m².

Example 11

[0046] A 0.1 mm-thick stainless steel with the composition of Ni 53 %, Cr 19 %, Fe 19 %, Mo 3 %, Nb + Tb 5 %, Ti 1 % (Inconel 718) was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0047] The density of the critical current in the superconducting film was of 0.15 MA/cm². Transition temperature was 87 K. A local substrate oxidation was observed after 120 min. lasting film deposition process.

[0048] The price of the substrate is of 6,300 DM/m².

Example 12

[0049] A 0.1 mm-thick stainless steel with the composition of Ni 72 %, Cr 16 %, Fe 8 %, Mn 1 %, Si 0,5 %, Co (Inconel 600) was used as the substrate 1. Buffer layer and superconducting film was applied as described in example 1.

[0050] The density of the critical current in the superconducting film was of 0.1 MA/cm². Transition temperature was 86 K. A local substrate oxidation was observed after 120 min. lasting film deposition process.

[0051] The price of the substrate is of 900 DM/m².

Example 13

[0052] At the same conditions as example 1 but with a substrate composition of Ni 19 % Cr 25 %, Fe 53 %, Mn 2 %, Si 0,75 % (steel SEW No. 1.4845 or ASTM No. 310 S).

[0053] The density of the critical current in the superconducting film was of 0.9 MA/cm². Transition temperature corresponds to 88 K. Some local substrate oxidation was observed after 120 min. lasting film deposition process.

[0054] The price of the substrate is of 614,-- DM/m².

[0055] The results of the experiments according to the above examples are summarised in Table 1.

[0056] It should be noted that all indications in % are based on weight (wt %).

Table 1. Comparison of quality of high-Tc superconducting films and substrate prices for different metallic substrates

No.	Substrate material	Substrate composition				Substrate treatment	Quality of high-Tc film		Price of substrate	Film deterioration caused by substrate oxidation
		Ni	Cr	Fe	other elements		Transition temperature	Critical current density		
1	Stainless steel	19 %	24 %	~53 %	Si 2 %, Mn 1 %	galvanic	90 K	2 MA/cm ²	20 DM/m ²	no
2	Stainless steel	25 %	24 %	~47 %	Si 1.5 %, Mn 2 %	galvanic	90 K	1.8 MA/cm ²	25 DM/m ²	no
3	Stainless steel	16 %	24 %	~56 %	Si 2 %, Mn 1 %	galvanic	89 K	1.5 MA/cm ²	20 DM/m ²	no
4	Stainless steel	19 %	18 %	~58 %	Si 2 %, Mn 2 %	galvanic	89 K	1.7 MA/cm ²	18 DM/m ²	no
5	Stainless steel	19 %	28 %	~50 %	Si 1.5 %, Mn 1 %	galvanic	88 K	1.5 MA/cm ²	25 DM/m ²	no
6	Stainless steel	19 %	24 %	~53 %	Si 2 %, Mn 1 %	thermal	90 K	1.7 MA/cm ²	20 DM/m ²	no
7	Stainless steel	8 %	18 %	~71 %	Mn 2 %	galvanic	87 K	0.1 MA/cm ²	15 DM/m ²	large
8	Stainless steel	9 %	18 %	~70 %	Ti 0.5 %, Mn 2 %	galvanic	86 K	< 0.1 MA/cm ²	22 DM/m ²	large
9	Hastelloy C	57 %	16 %	6 %	Mo 17 %, W 5 %	galvanic	88 K	1.5 MA/cm ²	2700 DM/m ²	local
10	Nickel	100 %	0 %	0 %		galvanic	88 K	1.4 MA/cm ²	1300 DM/m ²	large
11	Inconel 718	53 %	19 %	19 %	Mo 3%, Nb+Ta 5%, Ti 1%	galvanic	87 K	0.15 MA/cm ²	6300 DM/m ²	local
12	Inconel 600	72 %	16 %	8 %	Mn 1%, Co, Si 0.5 %	galvanic	86 K	0.1 MA/cm ²	900 DM/m ²	large
13	Stainless steel	19 %	25 %	~53 %	Si 0.75 %, Mn 2 %	galvanic	88 K	0.9 MA/cm ²	614 DM/m ²	small, local

Table 1 shows that the stainless steel according to the present invention (according to SEW steel No. 1.4841 (corresponding to ASTM 314 or SUS-314) shows a double as high critical current density compared with the stainless steel of example 9 having the SEW steel No. 1.4845 or ASTM 310 or SUS-310). Surprisingly the higher Si content of the steel according to the present invention has the effect of a much improved critical current density of the superconducting element.

Claims

1. Superconducting element comprising a high temperature superconducting film deposited on a technical substrate (1) consisting of a stainless steel which is composed of

C	0 to 0.20 %
Si	1.5 to 2.5 %
Mn	0 to 2.00 %
P	0 to 0.045 %
S	0 to 0.030 %
Cr	18.0 to 28.0 %
Ni	16.0 to 25.0 %
N	0 to 0.11 %, rest iron and unavoidable impurities.

rest iron and unavoidable impurities.

2. Superconducting element according to claim 1 wherein said steel shows a heat elongation of 15 to $18 \times 10^{-6}/K$ between 20° and $400^{\circ}C$, of 16 to $19 \times 10^{-6}/K$ between 20° and $800^{\circ}C$, of 17 to $20 \times 10^{-6}/K$ between 20° and $1000^{\circ}C$ and of 18 to $20.5 \times 10^{-6}/K$ between 20° and $1200^{\circ}C$.
3. Superconducting element according to claim 2 wherein said steel shows an heat elongation of $17 \times 10^{-6}/K$ between 20° and $400^{\circ}C$, $18 \times 10^{-6}/K$ between 20° and $800^{\circ}C$, of $19 \times 10^{-6}/K$ between 20° and $1000^{\circ}C$ and of $19.5 \times 10^{-6}/K$ between 20° and $1200^{\circ}C$.
4. Superconducting element according to one of claims 1 to 3, wherein the high temperature superconducting film consists of $YBa_2Cu_3O_{7-\delta}$.
5. Superconducting element according to claim 4 having a buffer layer between the substrate and the high temperature superconducting film.
6. Superconducting element according to claim 5, wherein the buffer layer is an Yttrium Stabilised Zirconia buffer layer.
7. Superconducting element according to claim 6, wherein the buffer layer has a thickness of $1 \mu m$.
8. Superconducting element according to one of the claims 1 to 7 having a Si content between 1.6 and 2.5 %, preferably between 1.7 and 2.5 %.
9. Superconducting element according to one of the claims 1 to 8 having a Cr content between 24.0 and 26.0 %.
10. Superconducting element according to one of the claims 1 to 9 having a Ni content between 19.0 and 22.0 %

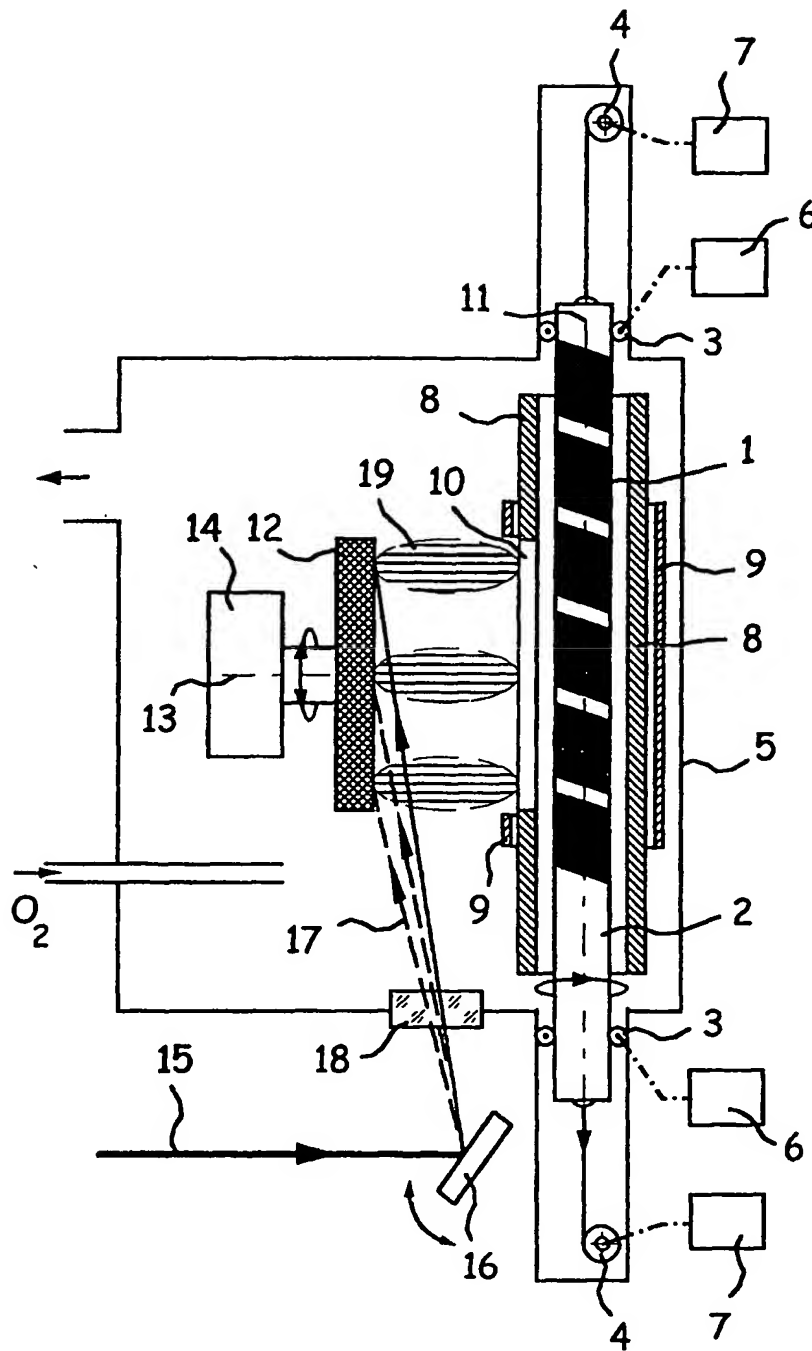


Fig. 1



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EUROPEAN SEARCH REPORT

Application Number
EP 01 10 1797

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
X	EP 0 447 198 A (NGK INSULATORS LTD) 18 September 1991 (1991-09-18) * page 16, line 3 - line 16; figure 8; example 43 *	1,9,10	H01L39/14
A	EP 0 312 015 A (FURUKAWA ELECTRIC CO LTD) 19 April 1989 (1989-04-19) * page 3, line 25 - line 48; example 18 *	1,4,5,9, 10	
A	PATENT ABSTRACTS OF JAPAN vol. 017, no. 400 (C-1089), 27 July 1993 (1993-07-27) & JP 05 078124 A (NISSHIN STEEL CO LTD), 30 March 1993 (1993-03-30) * abstract * -& JP 05 078124 A (NISSHIN STEEL CO LTD) 30 March 1993 (1993-03-30) * paragraph '0015! *	1,2,4,5, 9,10	
A	MINAMI N ET AL: "Preparation of YBa2Cu3O7-delta superconductor coating on austenitic steel by electrophoretic deposition method - study on buffering layers" JAPANESE JOURNAL OF APPLIED PHYSICS, PART 2 (LETTERS), vol. 31, no. 6B, 15 June 1992 (1992-06-15), pages 784-786, XP000323095 ISSN: 0021-4922 * page 784 *	1,2,4,5	TECHNICAL FIELDS SEARCHED (Int.Cl.7) H01L
A	EP 0 292 959 A (SUMITOMO ELECTRIC INDUSTRIES LTD) 30 November 1988 (1988-11-30) * column 2, line 36 - column 3, line 58; example 1; table 1 *	1,4-7	
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 10 July 2001	Examiner Köpf, C
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document		T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document	

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EUROPEAN SEARCH REPORT

Application Number
EP 01 10 1797

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
A	EP 0 441 724 A (EASTMAN KODAK CO) 14 August 1991 (1991-08-14) * page 2, line 2 - page 3, line 39; example 1 *	1	
L	--- C W WEGST: "Stahlschlüssel" 1989, VERLAG STAHLSCHEUESSEL WEGST, 15TH EDITION, MARBACH, GERMANY XP002140176 L: Zusammensetzung von rostfreien Stählen * page 350 - page 351 *		
L	--- LAMPMAN S R ET AL: "Metals Handbook. Properties and Selection: Irons, Steels, and High-Performance Alloys" 1990, ASM, 10TH EDITION, VOL. 1, , MATERIALS PARK, OH, US XP002140177 L: Zusammensetzung von rostfreien Stählen * page 842, section "Austenitic stainless steels" * * page 843, table 2 *		
			TECHNICAL FIELDS SEARCHED (Int.Cl.7)
The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 10 July 2001	Examiner Köpf, C
CATEGORY OF CITED DOCUMENTS X: particularly relevant if taken alone Y: particularly relevant if combined with another document of the same category A: technological background O: non-written disclosure P: intermediate document T: theory or principle underlying the invention E: earlier patent document, but published on, or after the filing date D: document cited in the application L: document cited for other reasons &: member of the same patent family, corresponding document			

EPO FORM 1603 03.82 (P04C01)

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ON EUROPEAN PATENT APPLICATION NO.**

EP 01 10 1797

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10-07-2001

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
EP 0447198 A	18-09-1991	JP 3265576 A	26-11-1991
		JP 3265577 A	26-11-1991
		JP 3275575 A	06-12-1991
		CA 2038012 A	15-09-1991
		US 5302580 A	12-04-1994
EP 0312015 A	19-04-1989	JP 1105412 A	21-04-1989
		JP 1115009 A	08-05-1989
		AU 610260 B	16-05-1991
		AU 2361388 A	20-04-1989
		CA 1324739 A	30-11-1993
		CN 1033336 A	07-06-1989
		DE 3877116 A	11-02-1993
		DE 3877116 T	19-05-1993
		KR 9705157 B	12-04-1997
		US 4994435 A	19-02-1991
JP 05078124 A	30-03-1993	NONE	
EP 0292959 A	30-11-1988	CA 1326976 A	15-02-1994
		DE 3888019 D	07-04-1994
		DE 3888019 T	09-06-1994
		JP 1087763 A	31-03-1989
		US 4921833 A	01-05-1990
EP 0441724 A	14-08-1991	US 5086035 A	04-02-1992
		CA 2035739 C	13-06-1995
		JP 5070132 A	23-03-1993

EPO FORM P068

For more details about this annex : see Official Journal of the European Patent Office, No. 12/82